

# SN54LV244A, SN74LV244A OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

SCLS383B – SEPTEMBER 1997 – REVISED JUNE 1998

- **EPIC™ (Enhanced-Performance Implanted CMOS) Process**
- **Typical  $V_{OLP}$  (Output Ground Bounce)**  
< 0.8 V at  $V_{CC}$ ,  $T_A = 25^\circ\text{C}$
- **Typical  $V_{OHV}$  (Output  $V_{OH}$  Undershoot)**  
> 2 V at  $V_{CC}$ ,  $T_A = 25^\circ\text{C}$
- **Latch-Up Performance Exceeds 250 mA Per JESD 17**
- **ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model ( $C = 200\text{ pF}$ ,  $R = 0$ )**
- **Package Options Include Plastic Small-Outline (DW, NS), Shrink Small-Outline (DB), Thin Very Small-Outline (DGV), and Thin Shrink Small-Outline (PW) Packages, Ceramic Flat (W) Packages, Chip Carriers (FK), and DIPs (J)**

## description

These octal buffers/line drivers are designed for 2-V to 5.5-V  $V_{CC}$  operation.

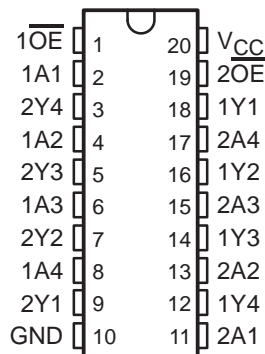
The 'LV244A devices are designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

These devices are organized as two 4-bit line drivers with separate output-enable ( $\overline{OE}$ ) inputs. When  $\overline{OE}$  is low, the device passes data from the A inputs to the Y outputs. When  $\overline{OE}$  is high, the outputs are in the high-impedance state.

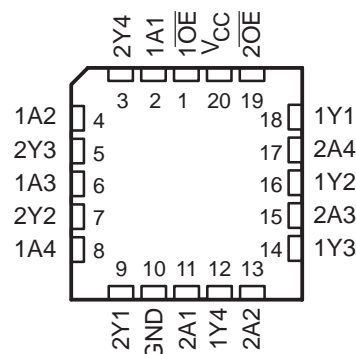
To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54LV244A is characterized for operation over the full military temperature range of  $-55^\circ\text{C}$  to  $125^\circ\text{C}$ . The SN74LV244A is characterized for operation from  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ .

SN54LV244A . . . J OR W PACKAGE  
SN74LV244A . . . DB, DGV, DW, NS, OR PW PACKAGE  
(TOP VIEW)



SN54LV244A . . . FK PACKAGE  
(TOP VIEW)



FUNCTION TABLE  
(each buffer)

INPUTS		OUTPUT Y
$\overline{OE}$	A	
L	H	H
L	L	L
H	X	Z



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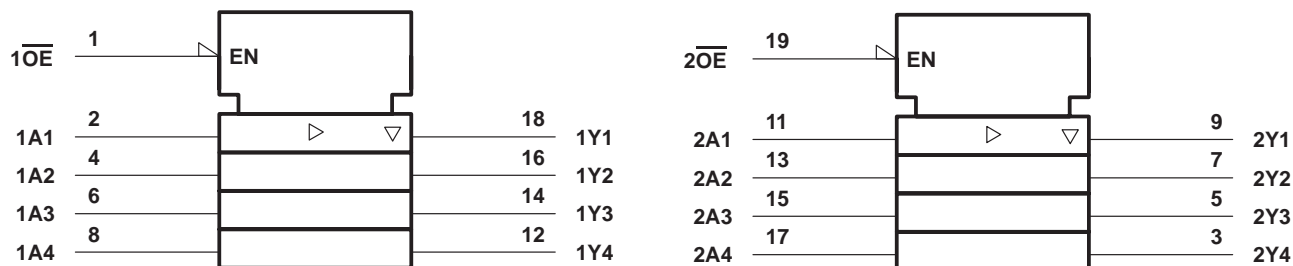
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**TEXAS  
INSTRUMENTS**

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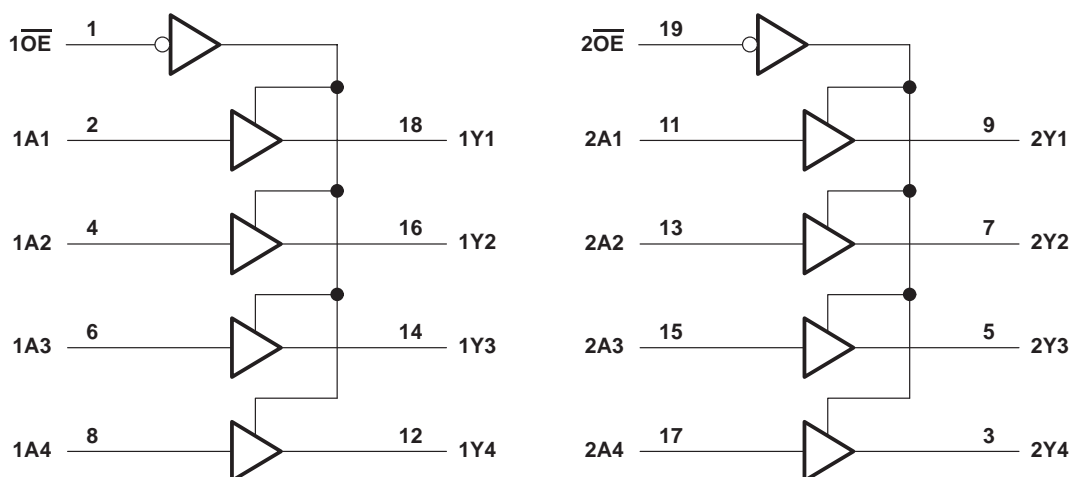
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## logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

## logic diagram (positive logic)



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, $V_{CC}$	–0.5 V to 7 V
Input voltage range, $V_I$ (see Note 1)	–0.5 V to 7 V
Output voltage range applied in the high or low state, $V_O$ (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Output voltage range applied in high-impedance or power-off state, $V_O$ (see Note 1)	–0.5 V to 7 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	–20 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ )	±50 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )	±35 mA
Continuous current through $V_{CC}$ or GND	±70 mA
Package thermal impedance, $\theta_{JA}$ (see Note 3):	
DB package	115°C/W
DGV package	146°C/W
DW package	97°C/W
NS package	100°C/W
PW package	128°C/W

Storage temperature range,  $T_{stg}$  ..... –65°C to 150°C

‡ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.  
 2. This value is limited to 7 V maximum.  
 3. The package thermal impedance is calculated in accordance with JESD 51.

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## recommended operating conditions (see Note 4)

			SN54LV244A		SN74LV244A		UNIT
			MIN	MAX	MIN	MAX	
V <sub>CC</sub>	Supply voltage		2	5.5	2	5.5	V
V <sub>IH</sub>	High-level input voltage	V <sub>CC</sub> = 2 V	1.5		1.5		V
		V <sub>CC</sub> = 2.3 V to 2.7 V	V <sub>CC</sub> × 0.7		V <sub>CC</sub> × 0.7		
		V <sub>CC</sub> = 3 V to 3.6 V	V <sub>CC</sub> × 0.7		V <sub>CC</sub> × 0.7		
		V <sub>CC</sub> = 4.5 V to 5.5 V	V <sub>CC</sub> × 0.7		V <sub>CC</sub> × 0.7		
V <sub>IL</sub>	Low-level input voltage	V <sub>CC</sub> = 2 V		0.5		0.5	V
		V <sub>CC</sub> = 2.3 V to 2.7 V		V <sub>CC</sub> × 0.3		V <sub>CC</sub> × 0.3	
		V <sub>CC</sub> = 3 V to 3.6 V		V <sub>CC</sub> × 0.3		V <sub>CC</sub> × 0.3	
		V <sub>CC</sub> = 4.5 V to 5.5 V		V <sub>CC</sub> × 0.3		V <sub>CC</sub> × 0.3	
V <sub>I</sub>	Input voltage		0	5.5	0	5.5	V
V <sub>O</sub>	Output voltage	High or low state	0	V <sub>CC</sub>	0	V <sub>CC</sub>	V
		3-state	0	5.5	0	5.5	
I <sub>OH</sub>	High-level output current	V <sub>CC</sub> = 2 V		–50		–50	μA
		V <sub>CC</sub> = 2.3 V to 2.7 V		–2		–2	mA
		V <sub>CC</sub> = 3 V to 3.6 V		–8		–8	
		V <sub>CC</sub> = 4.5 V to 5.5 V		–16		–16	
I <sub>OL</sub>	Low-level output current	V <sub>CC</sub> = 2 V		50		50	μA
		V <sub>CC</sub> = 2.3 V to 2.7 V		2		2	mA
		V <sub>CC</sub> = 3 V to 3.6 V		8		8	
		V <sub>CC</sub> = 4.5 V to 5.5 V		16		16	
Δt/Δv	Input transition rise or fall rate	V <sub>CC</sub> = 2.3 V to 2.7 V	0	200	0	200	ns/V
		V <sub>CC</sub> = 3 V to 3.6 V	0	100	0	100	
		V <sub>CC</sub> = 4.5 V to 5.5 V	0	20	0	20	
T <sub>A</sub>	Operating free-air temperature		–55	125	–40	85	°C

NOTE 4: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	V <sub>CC</sub>	SN54LV244A			SN74LV244A			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
V <sub>OH</sub>	I <sub>OH</sub> = -50 μA	2 V to 5.5 V	V <sub>CC</sub> -0.1			V <sub>CC</sub> -0.1			V
	I <sub>OH</sub> = -2 mA	2.3 V	2			2			
	I <sub>OH</sub> = -8 mA	3 V	2.48			2.48			
	I <sub>OH</sub> = -16 mA	4.5 V	3.8			3.8			
V <sub>OL</sub>	I <sub>OL</sub> = 50 μA	2 V to 5.5 V	0.1			0.1			V
	I <sub>OL</sub> = 2 mA	2.3 V	0.4			0.4			
	I <sub>OL</sub> = 8 mA	3 V	0.44			0.44			
	I <sub>OL</sub> = 16 mA	4.5 V	0.55			0.55			
I <sub>I</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND	5.5 V	±1			±1			μA
I <sub>OZ</sub>	V <sub>O</sub> = V <sub>CC</sub> or GND	5.5 V	±5			±5			μA
I <sub>CC</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0	5.5 V	20			20			μA
I <sub>off</sub>	V <sub>I</sub> or V <sub>O</sub> = 0 to 5.5 V	0 V	20			20			μA
C <sub>i</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND	3.3 V	2.3			2.3			pF
		5 V	2.3			2.3			

**switching characteristics over recommended operating free-air temperature range, V<sub>CC</sub> = 2.5 V ± 0.2 V (unless otherwise noted) (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T <sub>A</sub> = 25°C			SN54LV244A		SN74LV244A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>pd</sub> *	A	Y	C <sub>L</sub> = 15 pF	7.5	12.5		1	15	1	15	ns
t <sub>en</sub> *	$\overline{\text{OE}}$	Y		8.9	14.6		1	17	1	17	
t <sub>dis</sub> *	$\overline{\text{OE}}$	Y		9.1	14.1		1	16	1	16	
t <sub>pd</sub>	A	Y	C <sub>L</sub> = 50 pF	9.5	15.3		1	18	1	18	ns
t <sub>en</sub>	$\overline{\text{OE}}$	Y		10.8	17.8		1	21	1	21	
t <sub>dis</sub>	$\overline{\text{OE}}$	Y		13.4	19.2		1	21	1	21	
t <sub>sk(o)</sub> †					2					2	

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

† Skew between any two outputs of the same package switching in the same direction

**switching characteristics over recommended operating free-air temperature range, V<sub>CC</sub> = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T <sub>A</sub> = 25°C			SN54LV244A		SN74LV244A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>pd</sub> *	A	Y	C <sub>L</sub> = 15 pF	5.4	8.4		1	10	1	10	ns
t <sub>en</sub> *	$\overline{\text{OE}}$	Y		6.3	10.6		1	12.5	1	12.5	
t <sub>dis</sub> *	$\overline{\text{OE}}$	Y		7.6	11		1	13	1	13	
t <sub>pd</sub>	A	Y	C <sub>L</sub> = 50 pF	6.8	11.9		1	13.5	1	13.5	ns
t <sub>en</sub>	$\overline{\text{OE}}$	Y		7.8	14.1		1	16	1	16	
t <sub>dis</sub>	$\overline{\text{OE}}$	Y		11	16		1	18	1	18	
t <sub>sk(o)</sub> †					1.5					1.5	

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

† Skew between any two outputs of the same package switching in the same direction

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switching characteristics over recommended operating free-air temperature range,  
 $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$  (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T <sub>A</sub> = 25°C			SN54LV244A		SN74LV244A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>pd</sub> *	A	Y	C <sub>L</sub> = 15 pF	3.9	5.5	1	6.5	1	6.5	ns	
t <sub>en</sub> *	$\overline{OE}$	Y		4.5	7.3	1	8.5	1	8.5		
t <sub>dis</sub> *	$\overline{OE}$	Y		6.5	12.2	1	13.5	1	13.5		
t <sub>pd</sub>	A	Y	C <sub>L</sub> = 50 pF	4.9	7.5	1	8.5	1	8.5	ns	
t <sub>en</sub>	$\overline{OE}$	Y		5.6	9.3	1	10.5	1	10.5		
t <sub>dis</sub>	$\overline{OE}$	Y		8.8	14.2	1	15.5	1	15.5		
t <sub>sk(o)</sub> <sup>†</sup>				1			1				

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

† Skew between any two outputs of the same package switching in the same direction

noise characteristics,  $V_{CC} = 3.3\text{ V}$ ,  $C_L = 50\text{ pF}$ ,  $T_A = 25^\circ\text{C}$  (see Note 5)

PARAMETER		SN74LV244A			UNIT
		MIN	TYP	MAX	
$V_{OL(P)}$	Quiet output, maximum dynamic $V_{OL}$	0.55			V
$V_{OL(V)}$	Quiet output, minimum dynamic $V_{OL}$	-0.5			V
$V_{OH(V)}$	Quiet output, minimum dynamic $V_{OH}$	2.9			V
$V_{IH(D)}$	High-level dynamic input voltage	2.31			V
$V_{IL(D)}$	Low-level dynamic input voltage	0.99			V

NOTE 5: Characteristics are for surface-mount packages only.

operating characteristics,  $T_A = 25^\circ\text{C}$

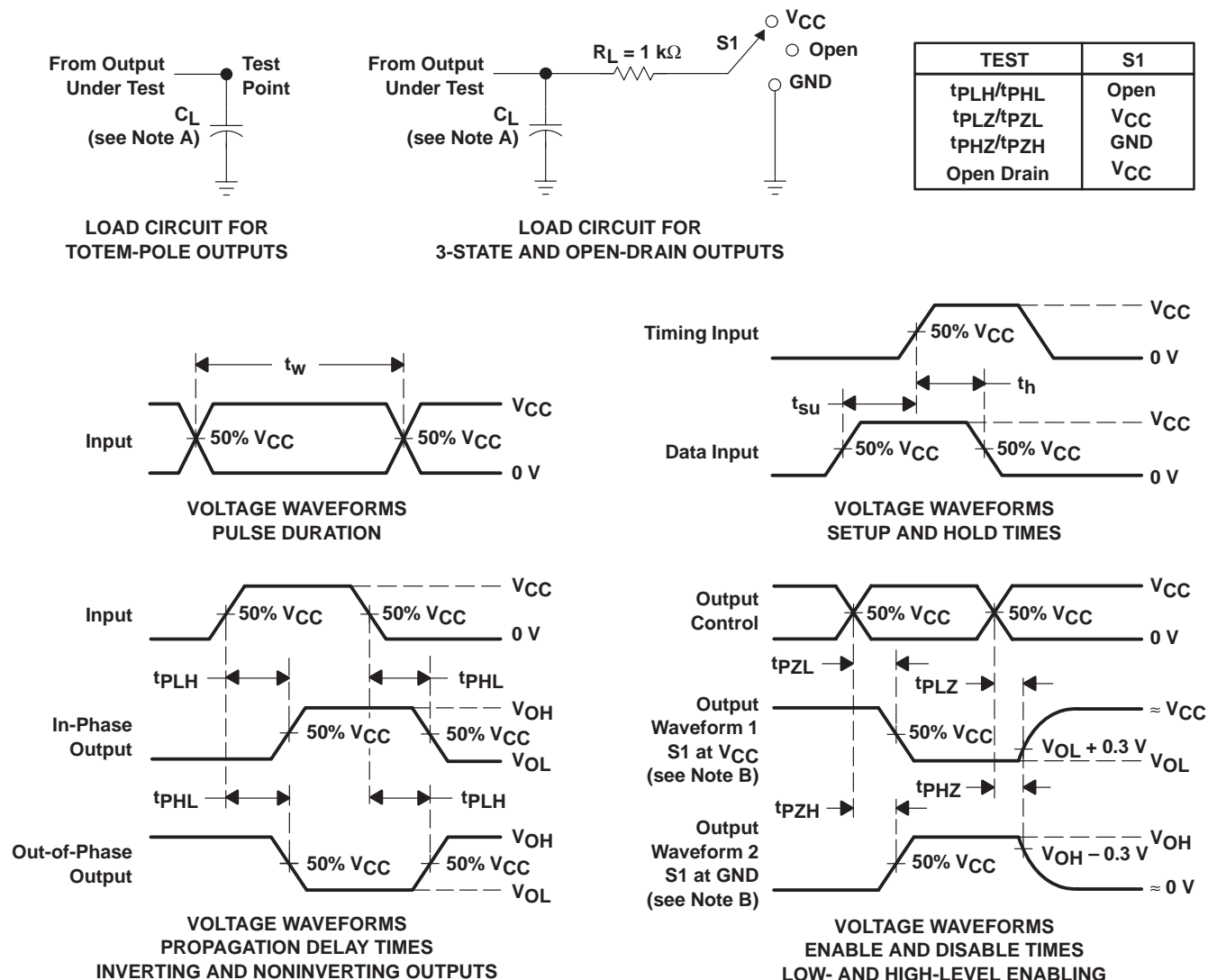
PARAMETER		TEST CONDITIONS		$V_{CC}$	TYP	UNIT
$C_{pd}$	Power dissipation capacitance	$C_L = 50\text{ pF}$ , $f = 10\text{ MHz}$		3.3 V	14	
				5 V	16	pF

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## PARAMETER MEASUREMENT INFORMATION



- NOTES: A.  $C_L$  includes probe and jig capacitance.  
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.  
C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 3\text{ ns}$ ,  $t_f \leq 3\text{ ns}$ .  
D. The outputs are measured one at a time with one input transition per measurement.  
E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .  
F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .  
G.  $t_{PHL}$  and  $t_{PLH}$  are the same as  $t_{pd}$ .

Figure 1. Load Circuit and Voltage Waveforms

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